

# MSP430F156 Device Erratasheet

## 1 Revision History

 $\checkmark$  The check mark indicates that the issue is present in the specified revision.

Errata Number	<ul> <li>Келе</li> <li>Келе<!--</th--><th>Kev D     Kev D     Kev D</th><th>V         V</th><th>&lt;       &lt;       &lt;</th></li></ul>	Kev D     Kev D     Kev D	V         V	<       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <       <
ADC18	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
ADC25	$\checkmark$	1	1	$\checkmark$
BCL5	$\checkmark$	1	1	$\checkmark$
CPU4	~	$\checkmark$	$\checkmark$	✓
I2C7	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C8	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C9	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C10	~	$\checkmark$	$\checkmark$	✓
I2C11	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C12	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C13	$\checkmark$	1	1	$\checkmark$
I2C14	~	~	~	$\checkmark$
I2C15 I2C16	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
I2C16	$\checkmark$	1	1	$\checkmark$
SVS2			~	$\checkmark$
TA12 TA16	~	~	~	$\checkmark$
TA16	~	~	~	$\checkmark$
TA21	$\checkmark$	$\checkmark$	$\checkmark$	$\checkmark$
TAB22	$\checkmark$	1	1	$\checkmark$
TB2	~	~	~	$\checkmark$
TB16	~	~	~	$\checkmark$
TB24	$\checkmark$	✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓ ✓	1	$\checkmark$
US14			1	$\checkmark$
US15	$\checkmark$	1	1	$\checkmark$
WDG2	$\checkmark$	1	1	$\checkmark$
XOSC4				✓

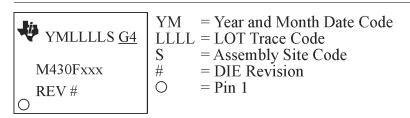


Package Markings

## 2 Package Markings

**PM64** 

LQFP (PM), 64 Pin



## RTD64

QFN (RTD), 64 Pin

O M430Fxxx TI YMS LLLL #	TI= TIYM= Year and Month Date CodeLLLL= LOT Trace CodeS= Assembly Site Code#= DIE RevisionO= Pin 1
<sup>O</sup> M430Fxxx	TI = TI YM = Year and Month Date Code
TI YMS <u>G3</u> LLLL #	LLLL = LOT Trace Code S = Assembly Site Code # = DIE Revision O = Pin 1

3	Detailed Bug Description		
	18	ADC12 Module	
Functi	on	Incorrect conversion result in extended sample mode	
Description		The ADC12 conversion result can be incorrect if the extended sample mode is selected $(SHP = 0)$ , the conversion clock is not the internal ADC12 oscillator (ADC12SSEL > 0), and one of the following two conditions is true:	
		<ul> <li>The extended sample input signal SHI is asynchronous to the clock source used for ADC12CLK and the undivided ADC12 input clock frequency exceeds 3.15 MHz.</li> </ul>	
		or	
		- The extended sample input signal SHI is synchronous to the clock source used for ADC12CLK and the undivided ADC12 input clock frequency exceeds 6.3 MHz.	
Worka	round	- Use the pulse sample mode (SHP = 1).	
		or	
		- Use the ADC12 internal oscillator as the ADC12 clock source.	
		or	
		- Limit the undivided ADC12 input clock frequency to 3.15 MHz.	
		or	
		<ul> <li>Use the same clock source (such as ACLK or SMCLK) to derive both SHI and ADC12CLK, to achieve synchronous operation, and also limit the undivided ADC12 input clock frequency to 6.3 MHz.</li> </ul>	
ADC2	25	ADC12 Module	
Functi	on	Write to ADC12CTL0 triggers ADC12 when CONSEQ = 00	
Descri	ption	If ADC conversions are triggered by the Timer_B module and the ADC12 is in single- channel single-conversion mode (CONSEQ = 00), ADC sampling is enabled by write access to any bit(s) in the ADC12CTL0 register. This is contrary to the expected behavior that only the ADC12 enable conversion bit (ADC12ENC) triggers a new ADC12 sample.	
Worka	round	When operating the ADC12 in CONSEQ=00 and a Timer_B output is selected as the sample and hold source, temporarily clear the ADC12ENC bit before writing to other bits in the ADC12CTL0 register. The following capture trigger can then be re-enabled by setting ADC12ENC = 1.	
BCL5	5	BCS Module	
Functi	on	RSELx bit modifications can generate high frequency spikes on MCLK	
Descri	ption	When $DIVMx = 00$ or 01 the RSELx bits of the Basic Clock Module are incremented or decremented in steps of 2 or greater, the DCO output may momentarily generate high frequency spikes on MCLK, which may corrupt CPU operation. This is not an issue when $DIVMx = 10$ or 11.	
Worka	round	Set DIVMx = 10 or 11 to divide the MCLK input prior to modifying RSELx. After the RSELx bits are configured as desired, the DIVMx setting can be changed back to the original selection.	



Detailed Bug Description	www.ti.com
CPU4	CPU Module
Function	PUSH #4, PUSH #8
Description	The single operand instruction PUSH cannot use the internal constants (CG) 4 and 8. The other internal constants (0, 1, 2, -1) can be used. The number of clock cycles is different:
	PUSH #CG uses address mode 00, requiring 3 cycles, 1 word instruction
	PUSH #4/#8 uses address mode 11, requiring 5 cycles, 2 word instruction
Workaround	Workaround implemented in assembler.
12C7	USART Module
Function	ARDYIFG Interrupt flag generation can fail in I2C slave mode.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C slave (U0CTL.MST=0), the ARDYIFG interrupt flag generation can fail, even when both the I2C stop condition is received and the receive buffer is empty.
	This condition occurs when the I2C clock source selected by I2CSSELx is disabled by the Status Register (SR) control signals OSCOFF or SCG1.
	In this configuration, the hardware clock activation is enabled by the I2C module. However, if RXRDYIFG is polled to determine data reception, the I2C hardware clock activation may be disabled before the ARDYIFG is generated.
Workaround	(1)Use interrupt service routines using the I2C interrupt vector generator feature (I2CIV) to handle all I2C interrupts.
	OR
	(2)After detection of I2C Own Address (OAIFG), the selected I2C clock source is enabled by clearing the OSCOFF or SCG1 Status Register (SR) bits. When the ARDYIFG is detected, the OSCOFF or SCG1 in the Status Register (SR) can be set to disable the clock source and return to the desired low power mode operation.
	OR
	(3)For slave only devices, it is normally not necessary to use ARDYIFG.
12C8	USART Module
Function	Master Transmitter transmits 0FFh continuously.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C master (U0CTL.MST=1) and I2CNDAT is used to control the number of bytes to transmit, the possibility exists that the master state-machine can become corrupted and start sending 0FFh as data on the I2C bus. Specifically, this error can occur when a long delay occurs between the set of the I2CTXRDY interrupt flag and the loading of I2CDRB (I2CDRW).
Workaround	After detection of the I2CTXRDY interrupt flag, verify that the I2CTXUDF bit in I2CDCTL is set before loading I2CDRB (I2CDRW).

4

SLAZ143B-October 2012-Revised May 2013 Submit Documentation Feedback

www.ti.com	Detailed Bug Description
I2C9	USART Module
Function	Master Transmitter Repeat Mode I2CSTP setting error.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C master (U0CTL.MST=1) and repeat mode operation is selected (I2CTCTL.I2CRM=1), the timing of the I2CSTP bit can result in lost data or extra requested transmitted bytes.
	Specifically, if interrupts are active during the following two cases:
	<ol> <li>During the time between the setting of the I2CSTP bit and loading of I2CDRB (I2CDRW).</li> </ol>
	<ol> <li>For transmitting slave address only, during the time between checking for I2CSTT cleared and setting I2CSTP.</li> </ol>
	Note: In the second case, the SCL line will be held low until the I2CDRB (I2CDRW) is loaded and then shifted out.
Workaround	Solution for case #1: disable all interrupts (DINT) before setting I2CSTP then re-enabling after loading of I2CDRB.
	Solution for case #2: disable all interrupts (DINT) before setting I2CSTT bit then re- enabling after setting I2CSTP bit.
I2C10	USART Module
Function	Master stop bit SCL low phase does not match I2CSCLL setting.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C master (U0CTL.MST=1), the hardware control of the SCL low phase before stop generation is equal to a single I2CCLK period. This is particularly noticeable with large I2CSCLL settings or large I2CPSC settings.
Workaround	None.
I2C11	USART Module
Function	Master state machine requires reset before new sequence can proceed.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C master (U0CTL.MST=1), the master state-machine does not properly reset between execution cycles.
Workaround	Before starting the new master sequence, clear and then re-set the I2CEN bit in the U0CTL register.
	bic.b #I2CEN,&U0CTL
	bis.b #I2CEN,&U0CTL
I2C12	USART Module
-	Moster/Slove lesses data on recention (last DXDDVIEC)



Detailed Bug Descri	ption www.ti.com
	from the internal I2C shift register into I2CDRB (I2CDRW), then the received data is lost and no corresponding receive ready interrupt (RXRDYIFG) is generated. Following RXRDYIFG interrupts are processed but the missing byte cannot be recovered.
Workaround	Do not read the I2CDRB(I2CDRW) register while data is being loaded into it. This can be ensured by reading this register in a timely manner using any one of the following methods:
	1) Handle RXRDYIFG events with all other interrupt sources disabled.
	<ol> <li>Use the DMA for receiving incoming I2C data. The DMA interrupt or ARDYIFG interrupt can be used to initiate further processing of received data.</li> </ol>
	<ol> <li>Enable nested interrupts to allow immediate processing of RXRDYIFG interrupts. (Care must be taken to avoid stack overflows).</li> </ol>
I2C13	USART Module
Function	Glitch on SCL between I2C communication cycles can corrupt the state machine in I2C master mode.
Description	When the USART is configured for I2C communication (U0CTL.I2C, SYNC, and I2CEN are set) and the module is configured as an I2C master (U0CTL.MST=1), the I2C module is automatically switched to slave mode following the I2C master's generation of a stop condition. If SCL is then pulled low and released again, the following device behavior can be observed:
	<ol> <li>When SCL is pulled low after the stop condition is generated and while ARDYIFG is not yet set, then ARDYIFG is not set as expected and ALIFG is set. SCL is released. See workaround 1 for details on how to handle this condition.</li> </ol>
	2) When SCL is pulled low at the same time as ARDYIFG is being set, ALIFG is set and SCL is released. Subsequent communication can result in an immediate ALIFG generation. See workaround 2 for details on how to handle this condition.
	3) When SCL is pulled low after ARDYIFG is set but before ARDYIFG is cleared, ALIFG is not set, but SCL is held low by the master. An SCL hang-up condition occurs. See workaround 3 for details on how to handle this condition.
	4) When SCL is pulled low after ARDYIFG is cleared, the module operates as intended. The ALIFG flag is not set and SCL is released.
Workaround	1. ALIFG must be processed. Data bytes are not affected.
	<ol><li>ALIFG must be processed. Data bytes are not affected. To avoid a second ALIFG, clear I2CEN and re-set I2CEN before new communication begins.</li></ol>
	<ol><li>Clear I2CEN and re-set I2CEN before new communication begins to clear the SCL hang-up.</li></ol>
I2C14	USART Module
Function	Master SCL phases do not match I2CSCLx settings.
Description	When the USART is configured for I2C mode (U0CTL.I2C, SYNC, and I2CEN are set) and the module is used as an I2C master (U0CTL.MST=1), the generated I2C shift clock (SCL) high and low phases may be one or more I2CIN clock periods longer than defined by I2CSCLH and I2CSCLL. High I2CIN frequencies, large external pull-up resistors, and a large capacitive bus loading on SCL increase the likelihood for this to occur.



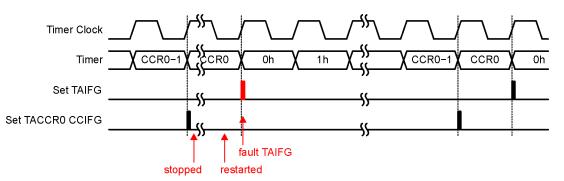
www.ti.com	Detailed Bug Description
Workaround	If possible, use an I2CIN input frequency of 1MHz or less. Additionally, use low- impedance I2C pull-up resistors, preferably in the lower single-digit k-Ohm range, and minimize capacitive load on SCL.
I2C15	USART Module
Function	I2CBUSY flag may clear before stop condition
Description	The I2CBUSY flag may already be cleared before the Stop condition on the bus is seen.
Workaround	Use the I2CBB flag instead of the I2CBUSY flag.
I2C16	USART Module
Function	I2C Slave may not detect own address correctly
Description	When an interrupt occurs between ACK and stop conditions of a slave transmission, the slave may not acknowledge the slave address byte if all below conditions are fulfilled:
	- STT interrupt is enabled
	- Device is in LPMx during start condition.
	If the failure occurs, the I2C state machine switches into IDLE state.
Workaround	(1)Do not use the STT interrupt for slave transmission.
	Or
	(2)Disable all interrupts between ACK and stop condition on I2C
SVS2	SVS Module
Function	DAC1 overwrites an input of the SVS comparator
Description	DAC1 overrides the input of the SVS comparator. This is caused by a conflict between SVS and DAC1 at Port 6.7. DAC1 is enabled when DAC12AMPx is > 0.
Workaround	Do not enable DAC1 when SVS is used.
TA12	TIMER_A Module
Function	Interrupt is lost (slow ACLK)
Description	Timer_A counter is running with slow clock (external TACLK or ACLK)compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.
Workaround	Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.



Description	The first increment of TAR after any timer clear event (POR/TACLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0,
	ID1). All following TAR increments are performed correctly with the selected IDx settings
Workaround	None

Function TAIFG Flag is erroneously set after Timer A restarts in Up Mode

**Description** In Up Mode, the TAIFG flag should only be set when the timer resets from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.



Workaround	No

one.

TAB22	TIMER_	_A/TIMER_	_B Module

 Function
 Timer\_A/Timer\_B register modification after Watchdog Timer PUC

**Description** Unwanted modification of the Timer\_A/Timer\_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer\_A/Timer\_B counter register TACCRx/TBCCRx is incremented/decremented (Timer\_A/Timer\_B does not need to be running).

**Workaround** Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.

Example code:

MOV.W #VAL, &TACTL

or

MOV.W #VAL, &TBCTL

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.

www.ti.com	Detailed Bug Description
TB2	TIMER_B Module
Function	Interrupt is lost (slow ACLK)
Description	Timer_B counter is running with slow clock (external TBCLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by 1 with the occurring compare interrupt (if TBR = CCRx).
	Due to the fast MCLK, the CCRx register increment (CCRx = CCRx + 1) happens before the Timer_B counter has incremented again. Therefore, the next compare interrupt should happen at once with the next Timer_B counter increment (if TBR = CCRx + 1). This interrupt is lost.
Workaround	Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterward.
TB16	TIMER_B Module
Function	First increment of TBR erroneous when $IDx > 00$
Description	The first increment of TBR after any timer clear event (POR/TBCLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK, or TBCLK). This is independent of the clock input divider settings (ID0, ID1). All following TBR increments are performed correctly with the selected IDx settings.
Workaround	None
TB24	TIMER_B Module
Function	TBIFG Flag is erroneously set after Timer B restarts in Up Mode
Description	In Up Mode, the TBIFG flag should only be set when the timer resets from TBCCR0 to zero. However, if the Timer A is stopped at TBR = TBCCR0, then cleared (TBR=0) by setting the TBCLR bit, and finally restarted in Up Mode, the next rising edge of the TBCLK will erroneously set the TBIFG flag.
г	Timer Clock
	Set TAIFG
Set TACC	CRO CCIFG
Workaround	None.
US14	USART Module
Function	Start edge of received characters may be ignored
Description	When using the USART in UART mode with $UxBR0 = 0x03$ and $UxBR1 = 0x00$ , the start edge of received characters may be ignored due to internal timing conflicts within the



Detailed Bug Description	www.ti.com
	UART state machine. This condition does not apply when UxBR0 is > 0x03.
Workaround	None
US15	USART Module
Function	UART receive with two stop bits
Description	USART hardware does not detect a missing second stop bit when SPB = 1.
	The Framing Error Flag (FE) will not be set under this condition and erroneous data reception may occur.
Workaround	None (Configure USART for a single stop bit, SPB = 0)
WDG2	WDT Module
Function	Incorrectly accessing a flash control register
Description	If a key violation is caused by incorrectly accessing a flash control register, the watchdog interrupt flag is set in addition to the expected PUC.
Workaround	None
XOSC4	XOSC Module
Function	XT1 high frequency oscillator low power wake-up error
Description	The XT1 high frequency oscillator wake-up from low power mode
	operation is not functional.
Workaround	If using the XT1 high frequency oscillator circuitry (BCSCTL1.XTS = 1),
	the OSCOFF bit in the Status Register (SR) must always be 0.



### 4 Document Revision History

Changes from family erratasheet to device specific erratasheet.

- 1. Errata I2C16 was added
- 2. Description for TAB22 was updated

Changes from device specific erratasheet to document Revision A.

1. Errata TA21 was added to the errata documentation.

Changes from document Revision A to Revision B.

1. Errata TB24 was added to the errata documentation.

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